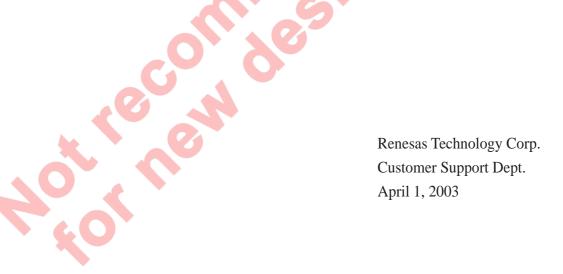
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2SA1337

Silicon PNP Epitaxial

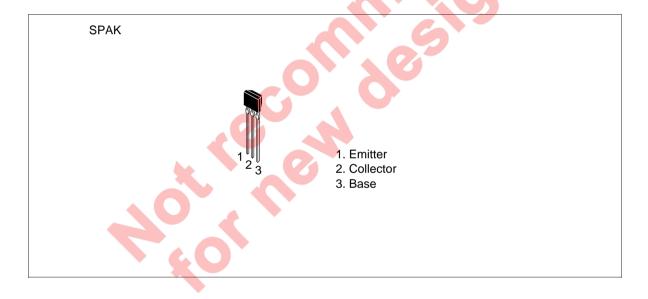


ADE-208-1014A (Z) 2nd. Edition Mar. 2001

Application

- Low frequency low noise amplifier
- HF amplifier

Outline



2SA1337

Absolute Maximum Ratings (Ta = 25°C)

| Item | Symbol | Ratings | Unit |
|------------------------------|------------------|-------------|------|
| Collector to base voltage | V_{CBO} | - 55 | V |
| Collector to emitter voltage | V_{CEO} | -50 | V |
| Emitter to base voltage | V_{EBO} | – 5 | V |
| Collector current | I _c | -100 | mA |
| Collector power dissipation | P _c | 300 | mW |
| Junction temperature | Tj | 150 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |

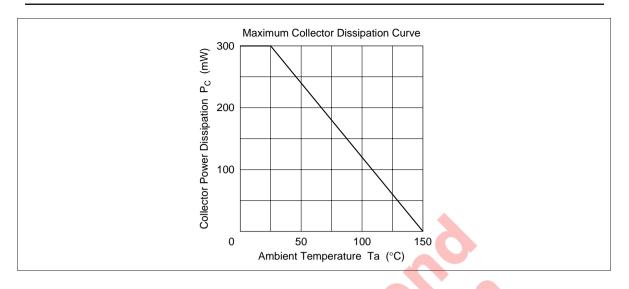
Electrical Characteristics ($Ta = 25^{\circ}C$)

| Item | Symbol | Min | Тур | Max | Unit | Test conditions |
|---|----------------------|-------------|--------------|-------|------|--|
| Collector to base breakdown voltage | $V_{(BR)CBO}$ | - 55 | _ | | V | $I_{c} = -10 \ \mu A, \ I_{E} = 0$ |
| Collector to emitter breakdown voltage | $V_{(BR)CEO}$ | -50 | 4 | _ | V | $I_{\rm C} = -1$ mA, $R_{\rm BE} = \infty$ |
| Emitter to base breakdown voltage | $V_{(BR)EBO}$ | -5 | | 8 | ٧ | $I_E = -10 \mu A, I_C = 0$ |
| Collector cutoff current | I _{CBO} | E) | | -0.5 | μΑ | $V_{CB} = -18 \text{ V}, I_{E} = 0$ |
| Emitter cutoff current | I _{EBO} | _ | | -0.5 | μΑ | $V_{EB} = -2 \text{ V}, I_{C} = 0$ |
| DC current transfer ratio | h _{FE} *1 | 100 | | 320 | | $V_{CE} = -12 \text{ V}, I_{C} = -2 \text{ mA}$ |
| Base to emitter voltage | V _{BE} | | - | -0.75 | V | $V_{CE} = -12 \text{ V}, I_{C} = -2 \text{ mA}$ |
| Collector to emitter saturation voltage | V _{CE(sat)} | | _ | -0.2 | V | $I_{\rm C} = -10 \text{ mA}, I_{\rm B} = -1 \text{ mA}$ |
| Gain bandwidth product | f _T | _ | 200 | _ | MHz | $V_{CE} = -12 \text{ V}, I_{C} = -2 \text{ mA}$ |
| Collector output capacitance | Cob | _ | _ | 4.5 | pF | $V_{CB} = -10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$ |
| Noise figure | NF | _ | 1.0 | 5.0 | dB | $V_{CE} = -6 \text{ V}, I_{C} = -0.1 \text{ mA},$ $R_{a} = 1 \text{ k}\Omega, f = 1 \text{ kHz}$ |

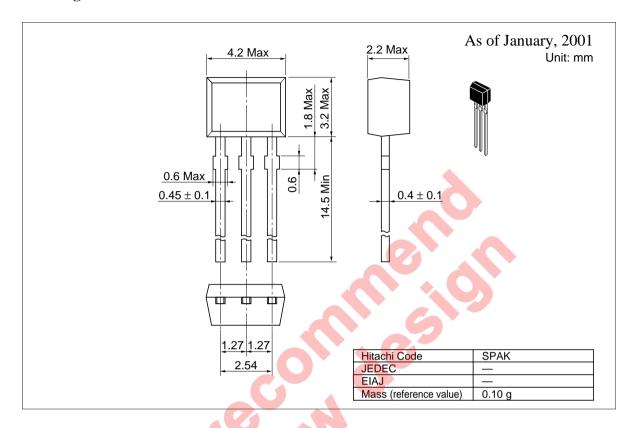
Note: 1. The 2SA1337 is grouped by $h_{\rm FE}$ as follows.

| В | С |
|------------|------------|
| 100 to 200 | 160 to 320 |

See characteristic curves of 2SA1052.



Package Dimensions



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